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CERTIFICATE OF MAILING

mereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner of Patents and Trademarks, Mail Stop Non-Fee Amendment, P.O. Box 1450, Alexandria, VA 22313, on the commissioner of Patents and Trademarks, Mail Stop Non-Fee Amendment, P.O. Box 1450, Alexandria, VA 22313, on the commissioner of Patents and Trademarks, Mail Stop Non-Fee Amendment, P.O. Box 1450, Alexandria, VA 22313, on the commissioner of Patents and Trademarks, Mail Stop Non-Fee Amendment, P.O. Box 1450, Alexandria, VA 22313, on the commissioner of Patents and Trademarks, Mail Stop Non-Fee Amendment, P.O. Box 1450, Alexandria, VA 22313, on the commissioner of Patents and Trademarks, Mail Stop Non-Fee Amendment, P.O. Box 1450, Alexandria, VA 22313, on the commissioner of Patents and Trademarks, Mail Stop Non-Fee Amendment, P.O. Box 1450, Alexandria, VA 22313, on the commissioner of Patents and Trademarks, Mail Stop Non-Fee Amendment, P.O. Box 1450, Alexandria, VA 22313, on the commissioner of Patents and Trademarks, Mail Stop Non-Fee Amendment, P.O. Box 1450, Alexandria, VA 22313, on the commissioner of Patents and Trademarks, Mail Stop Non-Fee Amendment, P.O. Box 1450, Alexandria, VA 22313, on the commissioner of Patents and Trademarks, Mail Stop Non-Fee Amendment, P.O. Box 1450, Alexandria, VA 22313, on the commissioner of Patents and Paten

Attorney for Applicant

PATENT Docket No. SJO920000145US1

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:	Tsann Lin et al.)
Serial No.:	10/040,061)
Filed:	January 4, 2002) Group Art) Unit: 1775
For:	SPIN-VALVE SENSOR WITH PINNING LAYERS COMPRISING MULTIPLE ANTIFERROMAGNETIC FILMS)))

Examiner: Vivek D. Koppikar

RESPONSE TO OFFICE ACTION

Mail Stop Non-Fee Amendment Commissioner for Patents and Trademarks P.O. Box 1450 Alexandria, VA 22313-1450

Dear Examiner:

In response to the Office Action mailed on May 7, 2003, Applicants respectfully request the reconsideration of the present application in view of the following remarks.